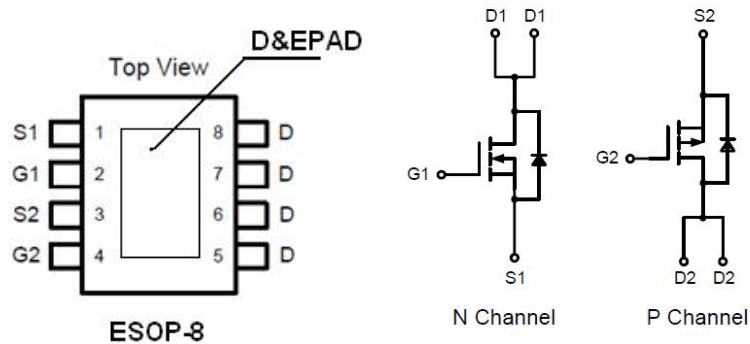




GENERAL DESCRIPTION

The RZC4608BE uses advanced trench technology to provide excellent $R_{DS(ON)}$ and low gate charge. The complementary MOSFETs may be used to form a level shifted high side switch, and for a host of other applications.

PIN CONFIGURATION



FEATURES

- N-Channel
40V/12A,
 $R_{DS(ON)}=9m\Omega$ (typ.) @ $V_{GS}=10V$
 $R_{DS(ON)}=12m\Omega$ (typ.) @ $V_{GS}=4.5V$
- P-Channel
-40V/-15A,
 $R_{DS(ON)}=42m\Omega$ (typ.) @ $V_{GS}=-10V$
 $R_{DS(ON)}=70m\Omega$ (typ.) @ $V_{GS}=-4.5V$
- Super High Dense Cell Design
- Reliable and Rugged

APPLICATIONS

- Power Management in Notebook Computer
- Portable Equipment
- Battery Powered Systems

ORDERING INFORMATION

Part Number	Package	Top Marking	Packing
RZC4608BE	ESOP-8	4608BE	3000PCS/Real

**MAXIMUM RATINGS** ($T_a = 25^{\circ}\text{C}$)

Parameter	Symbol		Value		Units
			N	P	
Drain to Source Voltage	V _{DSS}		40	-40	V
Gate to Source Voltage	V _{GSS}		±20	±20	V
Continuous Drain Current	ID	25°C	12	-15	A
		85°C	9.6	-12	A
Pulsed Drain Current	ID(pulse)		48	-60	A
Maximum Power Dissipation	PD(25°C)		2.0		W
Operating Junction Temperature	TJ		+150		°C
Storage Temperature	TSTG		-55-+150		°C
Lead Temperature for Soldering Purposes(1/8" from case for 10 s)	TL		260		°C

**ELECTRICAL CHARACTERISTICS** (TA = 25℃)**N-Channel**

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX	Units
Drain-Source Breakdown Voltage	BVDSS	V _{GS} =0V, I _{DS} =250uA	40			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 40V, V _{GS} =0V			1	uA
Gate Leakage Current	I _{GSS}	V _{GS} =±20V, V _{DS} =0V			±100	nA
Gate threshold voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D = 250μA			2.5	V
Drain to Source On-state Resistance	R _{DS(on)}	V _{GS} = 10V, I _D = 5.0A		9	12	mΩ
		V _{GS} = 4.5V, I _D = 5.0A		15	17	mΩ
Drain-Source Diode Forward Voltage	V _{SD}	I _S =1A, V _{GS} =0V		0.8	1.3	V
Input Capacitance	C _{iss}	V _{DS} =30V , V _{GS} =0V , f=1MHz		132 0		pF
Output Capacitance	C _{oss}			120		pF
Reverse Transfer Capacitance	C _{rss}			86		pF
Total Gate Charge (10V)	Q _g	V _{DS} =30V , V _{GS} =10V , I _D =5A		10.5		nC
Gate-Source Charge	Q _{gs}			4.2		nC
Gate-Drain Charge	Q _{gd}			3.0		nC



P-Channel

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX	Units
Drain-Source Breakdown Voltage	BVDSS	$V_{GS}=0V, I_{DS}=-250\mu A$	-40			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=-40V, V_{GS}=0V$			-1	μA
Gate Leakage Current	I_{GSS}	$V_{GS}=\pm 20V, V_{DS}=0V$			± 100	nA
Gate threshold voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=-250\mu A$	-1.0	-2.0	-3.0	V
Drain to Source On-state Resistance	$R_{DS(on)}$	$V_{GS}=-10V, I_D=-5.0A$		42	50	m Ω
		$V_{GS}=-4.5V, I_D=-5.0A$		65	75	m Ω
Drain-Source Diode Forward Voltage	V_{SD}	$I_S=-1A, V_{GS}=0V$		-0.8	-1.3	V
Input Capacitance	C_{iss}	$V_{DS}=-30V, V_{GS}=0V, f=1MHz$		850		pF
Output Capacitance	C_{oss}			170		pF
Reverse Transfer Capacitance	C_{rss}			110		pF
Total Gate Charge (10V)	Q_g	$V_{DS}=-30V, V_{GS}=-10V, I_D=-5A$		19		nC
Gate-Source Charge	Q_{gs}			3		nC
Gate-Drain Charge	Q_{gd}			4		nC



PACKAGE DIMENSIONS

ESOP-8

